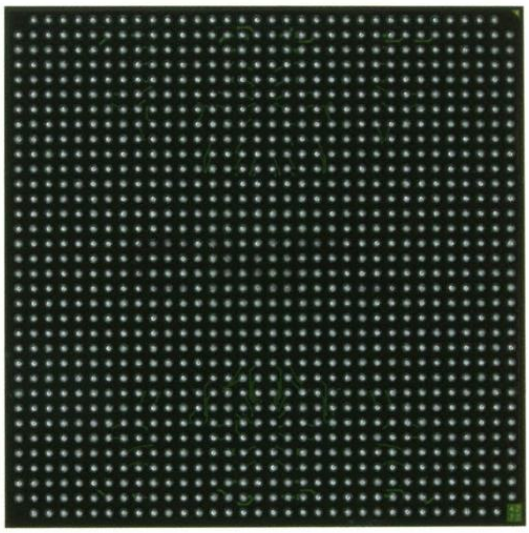

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Understanding Embedded - FPGAs (Field Programmable Gate Array)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details	
Product Status	Obsolete
Number of LABs/CLBs	5760
Number of Logic Elements/Cells	-
Total RAM Bits	2211840
Number of I/O	824
Number of Gates	4000000
Voltage - Supply	1.425V ~ 1.575V
Mounting Type	Surface Mount
Operating Temperature	-40°C ~ 100°C (TJ)
Package / Case	1152-BBGA, FCBGA
Supplier Device Package	1152-FCBGA (35x35)
Purchase URL	https://www.e-xfl.com/product-detail/xilinx/xc2v4000-5ff1152i

Revision History

This section records the change history for this module of the data sheet.

Date	Version	Revision
11/07/00	1.0	Early access draft.
12/06/00	1.1	Initial release.
01/15/01	1.2	Added values to the tables in the Virtex-II Performance Characteristics and Virtex-II Switching Characteristics sections.
01/25/01	1.3	The data sheet was divided into four modules (per the current style standard).
04/02/01	1.5	Skipped v1.4 to sync up modules. Reverted to traditional double-column format.
07/30/01	1.6	Made minor changes to items listed under Summary of Virtex-II™ Features.
10/02/01	1.7	Minor edits.
07/16/02	1.8	Updated Virtex-II Device/Package Combinations shown in Table 6.
09/26/02	1.9	Updated Table 2 and Table 6 to reflect supported Virtex-II Device/Package Combinations.
08/01/03	2.0	All Virtex-II devices and speed grades now Production. See Table 13, Module 3.
03/29/04	2.0.1	Recompiled for backward compatibility with Acrobat 4 and above. No content changes.
06/24/04	3.3	Added references to available Pb-free wire-bond packages. (Revision number advanced to level of complete data sheet.)
03/01/05	3.4	*No changes in Module 1 for this revision.*
11/05/07	3.5	Updated copyright notice and legal disclaimer.

Notice of Disclaimer

Virtex-II Data Sheet

The Virtex-II Data Sheet contains the following modules:

- Virtex-II Platform FPGAs: Introduction and Overview (Module 1)
- Virtex-II Platform FPGAs: Functional Description (Module 2)
- Virtex-II Platform FPGAs: DC and Switching Characteristics (Module 3)
- Virtex-II Platform FPGAs: Pinout Information (Module 4)

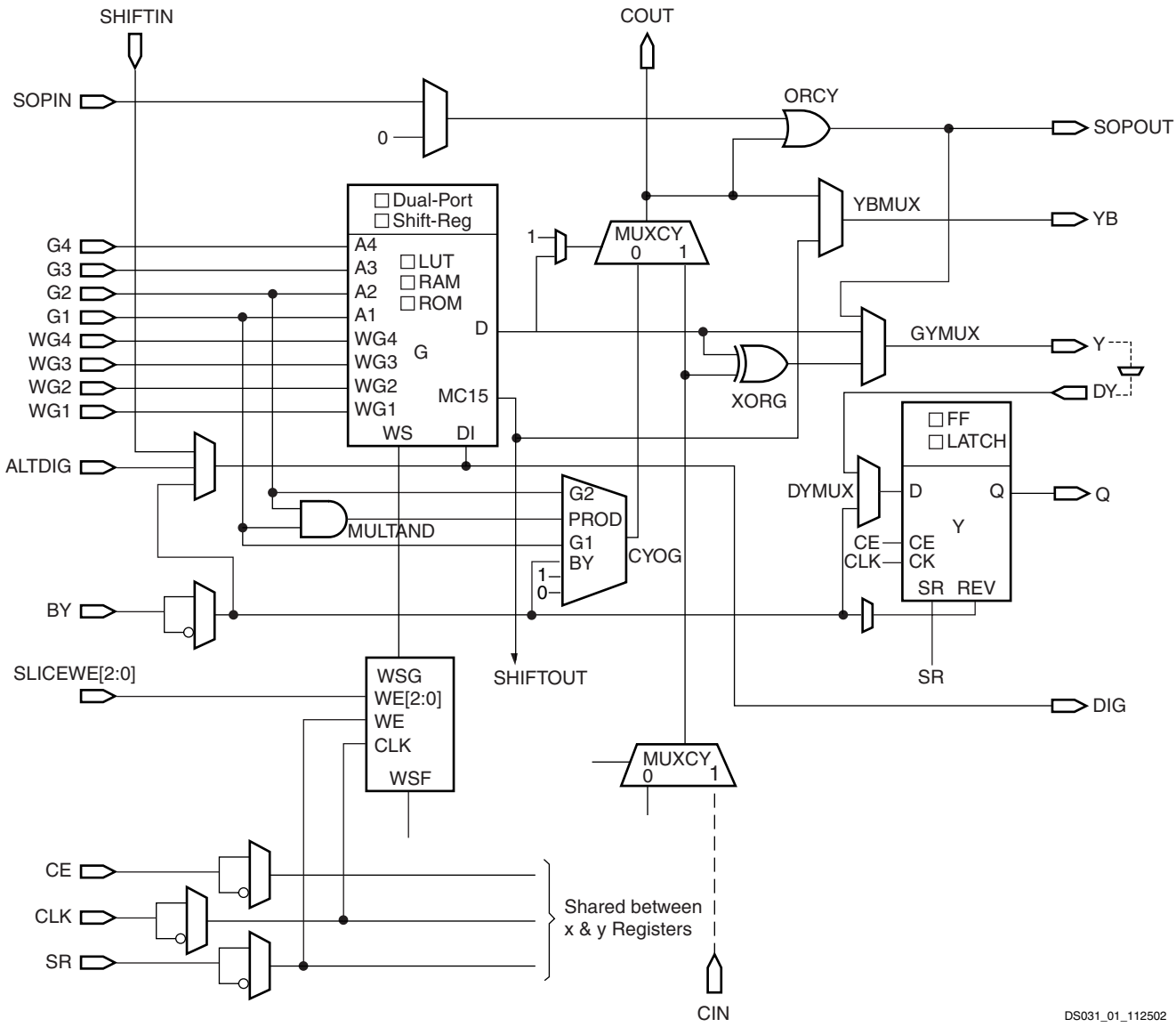

Figure 16: **Virtex-II Slice (Top Half)**

Figure 18, Figure 19, and Figure 20 illustrate various example configurations.

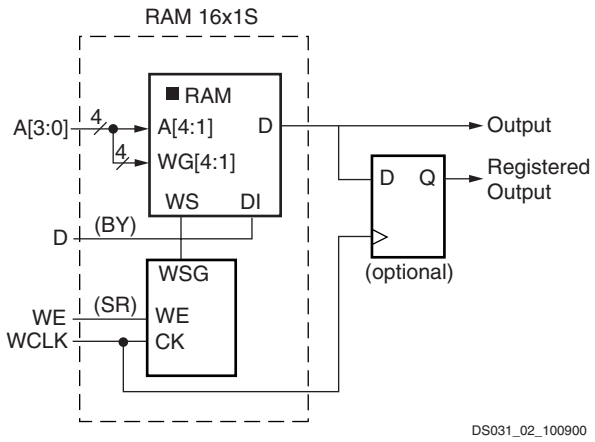

Figure 18: **Distributed SelectRAM (RAM16x1S)**

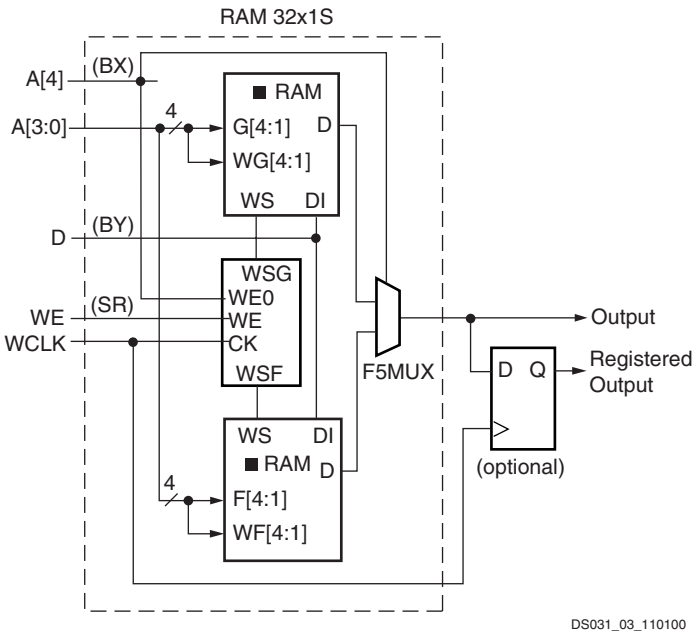

Figure 19: **Single-Port Distributed SelectRAM (RAM32x1S)**

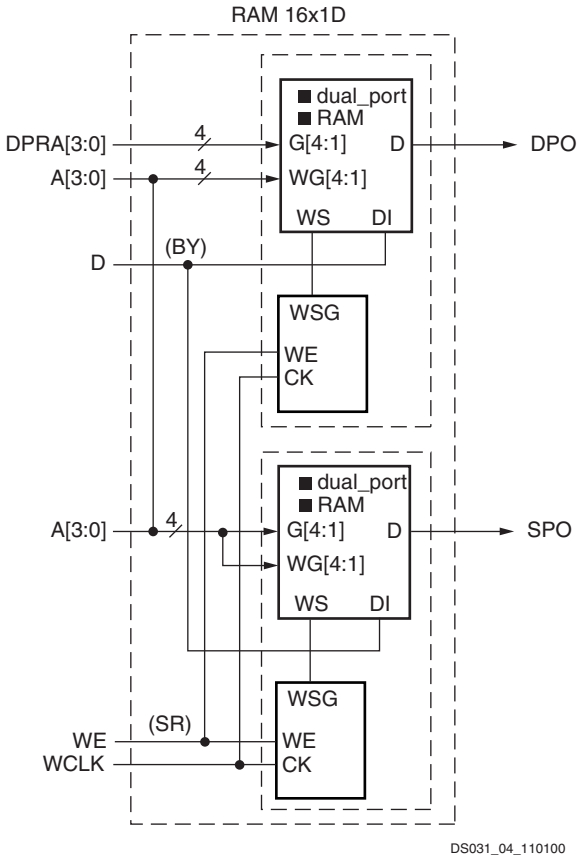

Figure 20: **Dual-Port Distributed SelectRAM (RAM16x1D)**

Similar to the RAM configuration, each function generator (LUT) can implement a 16 x 1-bit ROM. Five configurations are available: ROM16x1, ROM32x1, ROM64x1, ROM128x1, and ROM256x1. The ROM elements are cascadable to implement wider or/and deeper ROM. ROM contents are loaded at configuration. Table 10 shows the number of LUTs occupied by each configuration.

Table 10: **ROM Configuration**

ROM	Number of LUTs
16 x 1	1
32 x 1	2
64 x 1	4
128 x 1	8 (1 CLB)
256 x 1	16 (2 CLBs)

Each SelectRAM memory and multiplier block is tied to four switch matrices, as shown in Figure 35.

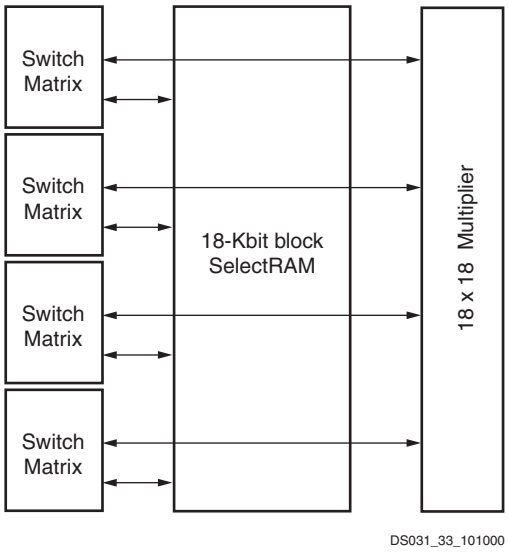

Figure 35: **SelectRAM and Multiplier Blocks**

Association With Block SelectRAM Memory

The interconnect is designed to allow SelectRAM memory and multiplier blocks to be used at the same time, but some interconnect is shared between the SelectRAM and the multiplier. Thus, SelectRAM memory can be used only up to 18 bits wide when the multiplier is used, because the multiplier shares inputs with the upper data bits of the SelectRAM memory.

This sharing of the interconnect is optimized for an 18-bit-wide block SelectRAM resource feeding the multiplier. The use of SelectRAM memory and the multiplier with an accumulator in LUTs allows for implementation of a digital signal processor (DSP) multiplier-accumulator (MAC) function, which is commonly used in finite and infinite impulse response (FIR and IIR) digital filters.

Configuration

The multiplier block is an 18-bit by 18-bit signed multiplier (2's complement). Both A and B are 18-bit-wide inputs, and the output is 36 bits. Figure 36 shows a multiplier block.

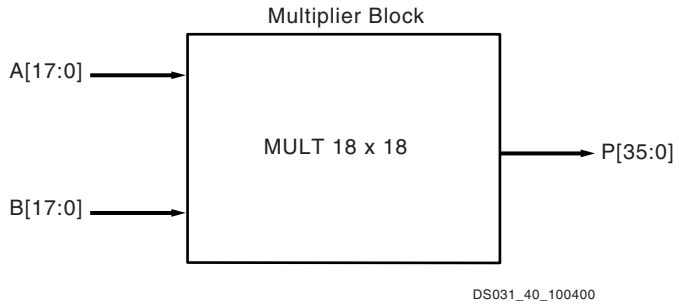

Figure 36: **Multiplier Block**

Locations / Organization

Multiplier organization is identical to the 18 Kbit SelectRAM organization, because each multiplier is associated with an 18 Kbit block SelectRAM resource.

In addition to the built-in multiplier blocks, the CLB elements have dedicated logic to implement efficient multipliers in logic. (Refer to Configurable Logic Blocks (CLBs)).

Table 20: **Multiplier Floor Plan**

Device	Columns	Multipliers	
		Per Column	Total
XC2V40	2	2	4
XC2V80	2	4	8
XC2V250	4	6	24
XC2V500	4	8	32
XC2V1000	4	10	40
XC2V1500	4	12	48
XC2V2000	4	14	56
XC2V3000	6	16	96
XC2V4000	6	20	120
XC2V6000	6	24	144
XC2V8000	6	28	168

Date	Version	Revision
08/01/03	3.0	• Table 13: All Virtex-II devices and speed grades now Production. • Updated values in Virtex-II Performance Characteristics and Virtex-II Switching Characteristics tables, based on values extracted from **speedsfile version 1.116**. • Table 34 and Table 35: Revised test setup footnote to refer to Figure 1. Previously specified a capacitive load parameter. • Figure 1: Added note to figure regarding termination resistors.
10/14/03	3.1	• Table 1: Changed T_J description from “Operating junction temperature” to “Maximum junction temperature”. • In section General Power Supply Requirements, replaced reference to Answer Record 11713 with reference to **XAPP689** regarding handling of simultaneously switching outputs (SSO). • In section I/O Standard Adjustment Measurement Methodology: - Table 18 renamed Input Delay Measurement Methodology. Added footnotes. - Added new Table 19, Output Delay Measurement Methodology. - Replaced Figure 1, Generalized Test Setup, with new drawing. - Revised and extended text describing output delay measurement procedure. • Table 45, Table 47, and Table 48: All Source-Synchronous parameters for all devices now available in these tables. • XC2V8000 is no longer offered in the -6 speed grade. The following tables containing parameters or other references to this device/grade combination were corrected accordingly: Table 13, Table 14, Table 34, Table 35, Table 36, Table 37, Table 45, Table 47, and Table 48. • Table 39: For Input Clock Low/High Pulse Width, PSCLK and CLKIN, changed existing Footnote (2) to new Footnote (3).
03/29/04	3.2	• Table 4: - For XC2V40, added Maximum quiescent supply current specifications. - For all devices, updated Typical specifications for I_{CCINTQ} and I_{CCAUXQ}. • Section Power-On Power Supply Requirements, page 3: Added Footnote (1) qualifying statement that power supplies can be turned on in any sequence. • Added section Configuration Timing, page 27. This section includes new timing diagrams as well as parameter specification tables formerly included in the **Virtex-II Platform FPGA User Guide**. • Table 20, Clock Distribution Switching Characteristics: Added parameter T_{GSI}/T_{GIS} (Global Clock Buffer S Input Setup/Hold to I1 and I2 Inputs). • Table 38, Operating Frequency Ranges: Added Footnote (4) to all four CLKIN parameters. • Recompiled for backward compatibility with Acrobat 4 and above.
06/24/04	3.3	• Table 1: Added T_{SOL} parameters for Pb-free package devices.
03/01/05	3.4	• Updated values in Virtex-II Performance Characteristics and Virtex-II Switching Characteristics tables, based on values extracted from **speedsfile version 1.120**. • Table 2: Corrected Footnote (1) to require connecting V_{BATT} to V_{CCAUX} or GND if battery is not used. • Table 3: Corrected "V_{REF} current per bank" to "V_{REF} current per pin." • Section Power-On Power Supply Requirements: Added word “monotonically” to description of supply voltage ramp-on requirements. Added sentence to footnote (1) indicating that if the stated requirements are violated, no damage to the device will result, but configuration will probably fail. • Figure 3 and Figure 4: Corrected to show DOUT transitions driven by falling edge of CCLK.

Table 7: **FG456/FGG456 BGA — XC2V250, XC2V500, and XC2V1000**

Bank	Pin Description	Pin Number	No Connect in XC2V250	No Connect in XC2V500
3	IO_L52P_3	P18	NC	
3	IO_L51N_3/VREF_3	P22	NC	
3	IO_L51P_3	P21	NC	
3	IO_L49N_3	P20	NC	
3	IO_L49P_3	P19	NC	
3	IO_L48N_3	R22		
3	IO_L48P_3	R21		
3	IO_L46N_3	R20		
3	IO_L46P_3	R19		
3	IO_L45N_3/VREF_3	R18		
3	IO_L45P_3	P17		
3	IO_L43N_3	T22		
3	IO_L43P_3	T21		
3	IO_L24N_3	T20	NC	NC
3	IO_L24P_3	T19	NC	NC
3	IO_L22N_3	U22	NC	NC
3	IO_L22P_3	U21	NC	NC
3	IO_L21N_3/VREF_3	U20	NC	NC
3	IO_L21P_3	U19	NC	NC
3	IO_L19N_3	T18	NC	NC
3	IO_L19P_3	U18	NC	NC
3	IO_L06N_3	V22		
3	IO_L06P_3	V21		
3	IO_L04N_3	V20		
3	IO_L04P_3	V19		
3	IO_L03N_3/VREF_3	W22		
3	IO_L03P_3	W21		
3	IO_L02N_3/VRP_3	Y22		
3	IO_L02P_3/VRN_3	Y21		
3	IO_L01N_3	W20		
3	IO_L01P_3	AA20		
4	IO_L01N_4/BUSY/DOUT(1)	AB19		
4	IO_L01P_4/INIT_B	AA19		

Table 8: **FG676/FGG676 BGA — XC2V1500, XC2V2000, and XC2V3000**

Bank	Pin Description	Pin Number	No Connect in XC2V1500	No Connect in XC2V2000
0	IO_L67P_0	C10		
0	IO_L69N_0	F10		
0	IO_L69P_0/VREF_0	G10		
0	IO_L70N_0	E10		
0	IO_L70P_0	D10		
0	IO_L72N_0	A10		
0	IO_L72P_0	A11		
0	IO_L73N_0	F11	NC	
0	IO_L73P_0	E11	NC	
0	IO_L75N_0	G11	NC	
0	IO_L75P_0/VREF_0	H11	NC	
0	IO_L76N_0	D11	NC	
0	IO_L76P_0	C11	NC	
0	IO_L78N_0	B11	NC	
0	IO_L78P_0	B12	NC	
0	IO_L91N_0/VREF_0	G12		
0	IO_L91P_0	H12		
0	IO_L92N_0	F12		
0	IO_L92P_0	E12		
0	IO_L93N_0	D12		
0	IO_L93P_0	C12		
0	IO_L94N_0/VREF_0	G13		
0	IO_L94P_0	H13		
0	IO_L95N_0/GCLK7P	F13		
0	IO_L95P_0/GCLK6S	E13		
0	IO_L96N_0/GCLK5P	D13		
0	IO_L96P_0/GCLK4S	C13		
1	IO_L96N_1/GCLK3P	H14		
1	IO_L96P_1/GCLK2S	H15		
1	IO_L95N_1/GCLK1P	G14		
1	IO_L95P_1/GCLK0S	F14		
1	IO_L94N_1	E14		
1	IO_L94P_1/VREF_1	D14		
1	IO_L93N_1	A12		
1	IO_L93P_1	A13		
1	IO_L92N_1	A14		

Table 8: **FG676/FGG676 BGA — XC2V1500, XC2V2000, and XC2V3000**

Bank	Pin Description	Pin Number	No Connect in XC2V1500	No Connect in XC2V2000
7	IO_L21P_7/VREF_7	F3		
7	IO_L21N_7	F2		
7	IO_L19P_7	H6		
7	IO_L19N_7	H7		
7	IO_L06P_7	E1		
7	IO_L06N_7	E2		
7	IO_L04P_7	D1		
7	IO_L04N_7	D2		
7	IO_L03P_7/VREF_7	C1		
7	IO_L03N_7	C2		
7	IO_L02P_7/VRN_7	E3		
7	IO_L02N_7/VRP_7	E4		
7	IO_L01P_7	G5		
7	IO_L01N_7	F4		
0	VCCO_0	J13		
0	VCCO_0	J12		
0	VCCO_0	J11		
0	VCCO_0	H10		
0	VCCO_0	H9		
0	VCCO_0	B10		
0	VCCO_0	B7		
1	VCCO_1	B17		
1	VCCO_1	J16		
1	VCCO_1	J15		
1	VCCO_1	J14		
1	VCCO_1	H18		
1	VCCO_1	H17		
1	VCCO_1	B20		
2	VCCO_2	N18		
2	VCCO_2	M18		
2	VCCO_2	L18		
2	VCCO_2	K25		
2	VCCO_2	K19		
2	VCCO_2	J19		
2	VCCO_2	G25		
3	VCCO_3	Y25		

BG575/BGG575 Standard BGA Package

As shown in Table 9, XC2V1000, XC2V1500, and XC2V2000 Virtex-II devices are available in the BG575/BGG575 BGA package. Pins in the XC2V1000, XC2V1500, and XC2V2000 devices are the same, except for the pin differences in the XC2V1000 and XC2V1500 devices shown in the No Connect columns. Following this table are the BG575/BGG575 Standard BGA Package Specifications (1.27mm pitch).

Table 9: **BG575/BGG575 BGA — XC2V1000, XC2V1500, and XC2V2000**

Bank	Pin Description	Pin Number	No Connect in XC2V1000	No Connect in XC2V1500
0	IO_L01N_0	A3		
0	IO_L01P_0	A4		
0	IO_L02N_0	D5		
0	IO_L02P_0	C5		
0	IO_L03N_0/VRP_0	E6		
0	IO_L03P_0/VRN_0	D6		
0	IO_L04N_0/VREF_0	F7		
0	IO_L04P_0	E7		
0	IO_L05N_0	G8		
0	IO_L05P_0	H9		
0	IO_L06N_0	A5		
0	IO_L06P_0	A6		
0	IO_L19N_0	B5		
0	IO_L19P_0	B6		
0	IO_L21N_0	D7		
0	IO_L21P_0/VREF_0	C7		
0	IO_L22N_0	F8		
0	IO_L22P_0	E8		
0	IO_L24N_0	G9		
0	IO_L24P_0	F9		
0	IO_L49N_0	G10		
0	IO_L49P_0	H10		
0	IO_L51N_0	B7		
0	IO_L51P_0/VREF_0	B8		
0	IO_L52N_0	D8		
0	IO_L52P_0	C8		
0	IO_L54N_0	E9		
0	IO_L54P_0	D9		
0	IO_L67N_0	A8	NC	
0	IO_L67P_0	A9	NC	
0	IO_L69N_0	C9	NC	

Table 10: **BG728 BGA — XC2V3000**

Bank	Pin Description	Pin Number
1	IO_L27N_1/VREF_1	F19
1	IO_L27P_1	G19
1	IO_L25N_1	J19
1	IO_L25P_1	J20
1	IO_L24N_1	C20
1	IO_L24P_1	C21
1	IO_L22N_1	D20
1	IO_L22P_1	E21
1	IO_L21N_1/VREF_1	E20
1	IO_L21P_1	F20
1	IO_L19N_1	A21
1	IO_L19P_1	B21
1	IO_L06N_1	A22
1	IO_L06P_1	B22
1	IO_L05N_1	C22
1	IO_L05P_1	C23
1	IO_L04N_1	D22
1	IO_L04P_1/VREF_1	E22
1	IO_L03N_1/VRP_1	A23
1	IO_L03P_1/VRN_1	B23
1	IO_L02N_1	A24
1	IO_L02P_1	B24
1	IO_L01N_1	A25
1	IO_L01P_1	B25
2	IO_L01N_2	C27
2	IO_L01P_2	D27
2	IO_L02N_2/VRP_2	D25
2	IO_L02P_2/VRN_2	D26
2	IO_L03N_2	E24
2	IO_L03P_2/VREF_2	E25
2	IO_L04N_2	E26
2	IO_L04P_2	E27
2	IO_L06N_2	F23
2	IO_L06P_2	F24
2	IO_L19N_2	F25

Table 10: **BG728 BGA — XC2V3000**

Bank	Pin Description	Pin Number
7	IO_L27P_7/VREF_7	H5
7	IO_L27N_7	H6
7	IO_L25P_7	J7
7	IO_L25N_7	J8
7	IO_L24P_7	G1
7	IO_L24N_7	F1
7	IO_L22P_7	G2
7	IO_L22N_7	G3
7	IO_L21P_7/VREF_7	F2
7	IO_L21N_7	F3
7	IO_L19P_7	G5
7	IO_L19N_7	G6
7	IO_L06P_7	F4
7	IO_L06N_7	F5
7	IO_L04P_7	E1
7	IO_L04N_7	E2
7	IO_L03P_7/VREF_7	D1
7	IO_L03N_7	C1
7	IO_L02P_7/VRN_7	E3
7	IO_L02N_7/VRP_7	E4
7	IO_L01P_7	D2
7	IO_L01N_7	D3
0	VCCO_0	K13
0	VCCO_0	K12
0	VCCO_0	K11
0	VCCO_0	J11
0	VCCO_0	J10
0	VCCO_0	G12
0	VCCO_0	D7
0	VCCO_0	C12
1	VCCO_1	K17
1	VCCO_1	K16
1	VCCO_1	K15
1	VCCO_1	J18
1	VCCO_1	J17

Table 13: **FF1517 BGA — XC2V4000, XC2V6000, and XC2V8000**

Bank	Pin Description	Pin Number	No Connect in the XC2V4000	No Connect in the XC2V6000
1	IO_L93N_1	E19		
1	IO_L93P_1	E20		
1	IO_L92N_1	J19		
1	IO_L92P_1	J18		
1	IO_L91N_1	A18		
1	IO_L91P_1/VREF_1	A19		
1	IO_L84N_1	D18		
1	IO_L84P_1	D19		
1	IO_L83N_1	K19		
1	IO_L83P_1	K18		
1	IO_L82N_1	B18		
1	IO_L82P_1	B19		
1	IO_L81N_1/VREF_1	G18		
1	IO_L81P_1	G19		
1	IO_L80N_1	E18		
1	IO_L80P_1	E17		
1	IO_L79N_1	A16		
1	IO_L79P_1	A17		
1	IO_L78N_1	F17		
1	IO_L78P_1	F18		
1	IO_L77N_1	L19		
1	IO_L77P_1	L18		
1	IO_L76N_1	B16		
1	IO_L76P_1	B17		
1	IO_L75N_1/VREF_1	G16		
1	IO_L75P_1	G17		
1	IO_L74N_1	M19		
1	IO_L74P_1	M18		
1	IO_L73N_1	C16		
1	IO_L73P_1	C17		
1	IO_L72N_1	D15		
1	IO_L72P_1	D16		
1	IO_L71N_1	J17		
1	IO_L71P_1	J16		
1	IO_L70N_1	A14		
1	IO_L70P_1	A15		

Table 13: **FF1517 BGA — XC2V4000, XC2V6000, and XC2V8000**

Bank	Pin Description	Pin Number	No Connect in the XC2V4000	No Connect in the XC2V6000
2	IO_L33P_2/VREF_2	J4	NC	
2	IO_L34N_2	K2	NC	
2	IO_L34P_2	J2	NC	
2	IO_L35N_2	P12	NC	
2	IO_L35P_2	R12	NC	
2	IO_L36N_2	M6	NC	
2	IO_L36P_2	L6	NC	
2	IO_L43N_2	L3		
2	IO_L43P_2	K3		
2	IO_L44N_2	N9		
2	IO_L44P_2	P9		
2	IO_L45N_2	M4		
2	IO_L45P_2/VREF_2	L4		
2	IO_L46N_2	L1		
2	IO_L46P_2	K1		
2	IO_L47N_2	P10		
2	IO_L47P_2	R10		
2	IO_L48N_2	N5		
2	IO_L48P_2	M5		
2	IO_L49N_2	N3		
2	IO_L49P_2	M3		
2	IO_L50N_2	N8		
2	IO_L50P_2	P8		
2	IO_L51N_2	T11		
2	IO_L51P_2/VREF_2	R11		
2	IO_L52N_2	N2		
2	IO_L52P_2	M2		
2	IO_L53N_2	T12		
2	IO_L53P_2	U12		
2	IO_L54N_2	P6		
2	IO_L54P_2	N6		
2	IO_L55N_2	N1		
2	IO_L55P_2	M1		
2	IO_L56N_2	R8		
2	IO_L56P_2	T8		
2	IO_L57N_2	R7		

Table 13: **FF1517 BGA — XC2V4000, XC2V6000, and XC2V8000**

Bank	Pin Description	Pin Number	No Connect in the XC2V4000	No Connect in the XC2V6000
6	VCCO_6	AG33		
6	VCCO_6	AF38		
6	VCCO_6	AF27		
6	VCCO_6	AE31		
6	VCCO_6	AE27		
6	VCCO_6	AE26		
6	VCCO_6	AD27		
6	VCCO_6	AD26		
6	VCCO_6	AC29		
6	VCCO_6	AC27		
6	VCCO_6	AC26		
6	VCCO_6	AB37		
6	VCCO_6	AB27		
6	VCCO_6	AB26		
6	VCCO_6	AA27		
6	VCCO_6	AA26		
7	VCCO_7	W27		
7	VCCO_7	W26		
7	VCCO_7	V37		
7	VCCO_7	V27		
7	VCCO_7	V26		
7	VCCO_7	U29		
7	VCCO_7	U27		
7	VCCO_7	U26		
7	VCCO_7	T27		
7	VCCO_7	T26		
7	VCCO_7	R31		
7	VCCO_7	R27		
7	VCCO_7	R26		
7	VCCO_7	P38		
7	VCCO_7	P27		
7	VCCO_7	N33		
7	VCCO_7	L35		
NA	CCLK	AT5		
NA	PROG_B	H31		

Table 13: **FF1517 BGA — XC2V4000, XC2V6000, and XC2V8000**

Bank	Pin Description	Pin Number	No Connect in the XC2V4000	No Connect in the XC2V6000
NA	GND	AC20		
NA	GND	AC19		
NA	GND	AC18		
NA	GND	AC17		
NA	GND	AC16		
NA	GND	AC8		
NA	GND	AC4		
NA	GND	AB24		
NA	GND	AB23		
NA	GND	AB22		
NA	GND	AB21		
NA	GND	AB20		
NA	GND	AB19		
NA	GND	AB18		
NA	GND	AB17		
NA	GND	AB16		
NA	GND	AA24		
NA	GND	AA23		
NA	GND	AA22		
NA	GND	AA21		
NA	GND	AA20		
NA	GND	AA19		
NA	GND	AA18		
NA	GND	AA17		
NA	GND	AA16		
NA	GND	Y39		
NA	GND	Y36		
NA	GND	Y33		
NA	GND	Y30		
NA	GND	Y24		
NA	GND	Y23		
NA	GND	Y22		
NA	GND	Y21		
NA	GND	Y20		
NA	GND	Y19		
NA	GND	Y18		

Table 14: **BF957 — XC2V2000, XC2V3000, XC2V4000, and XC2V6000**

Bank	Pin Description	Pin Number	No Connect in XC2V2000
1	IO_L71P_1	B12	
1	IO_L70N_1	C13	
1	IO_L70P_1	C12	
1	IO_L69N_1/VREF_1	H13	
1	IO_L69P_1	H12	
1	IO_L68N_1	D12	
1	IO_L68P_1	D11	
1	IO_L67N_1	B11	
1	IO_L67P_1	B10	
1	IO_L54N_1	E12	
1	IO_L54P_1	E11	
1	IO_L53N_1	A11	
1	IO_L53P_1	A10	
1	IO_L52N_1	G12	
1	IO_L52P_1	G11	
1	IO_L51N_1/VREF_1	K13	
1	IO_L51P_1	K12	
1	IO_L50N_1	C11	
1	IO_L50P_1	C10	
1	IO_L49N_1	B9	
1	IO_L49P_1	B7	
1	IO_L30N_1	F11	NC
1	IO_L30P_1	F9	NC
1	IO_L29N_1	A9	NC
1	IO_L29P_1	A8	NC
1	IO_L27N_1/VREF_1	D9	NC
1	IO_L27P_1	D8	NC
1	IO_L26N_1	J12	NC
1	IO_L26P_1	J11	NC
1	IO_L25N_1	C9	NC
1	IO_L25P_1	C8	NC
1	IO_L24N_1	E10	
1	IO_L24P_1	E9	
1	IO_L23N_1	H11	
1	IO_L23P_1	H10	
1	IO_L22N_1	A7	
1	IO_L22P_1	A6	
1	IO_L21N_1/VREF_1	A5	

Table 14: **BF957 — XC2V2000, XC2V3000, XC2V4000, and XC2V6000**

Bank	Pin Description	Pin Number	No Connect in XC2V2000
2	IO_L70N_2	K1	
2	IO_L70P_2	L1	
2	IO_L71N_2	N9	
2	IO_L71P_2	P9	
2	IO_L72N_2	N5	
2	IO_L72P_2	P5	
2	IO_L73N_2	M3	
2	IO_L73P_2	N3	
2	IO_L74N_2	R8	
2	IO_L74P_2	R9	
2	IO_L75N_2	M2	
2	IO_L75P_2/VREF_2	N2	
2	IO_L76N_2	M1	
2	IO_L76P_2	N1	
2	IO_L77N_2	P7	
2	IO_L77P_2	R7	
2	IO_L78N_2	N4	
2	IO_L78P_2	P4	
2	IO_L91N_2	T8	
2	IO_L91P_2	T9	
2	IO_L92N_2	P6	
2	IO_L92P_2	R6	
2	IO_L93N_2	P2	
2	IO_L93P_2/VREF_2	R2	
2	IO_L94N_2	R5	
2	IO_L94P_2	T5	
2	IO_L95N_2	P1	
2	IO_L95P_2	R1	
2	IO_L96N_2	R4	
2	IO_L96P_2	R3	
3	IO_L96N_3	T6	
3	IO_L96P_3	U5	
3	IO_L95N_3	U6	
3	IO_L95P_3	V6	
3	IO_L94N_3	T3	
3	IO_L94P_3	U3	
3	IO_L93N_3/VREF_3	U1	

Table 14: **BF957 — XC2V2000, XC2V3000, XC2V4000, and XC2V6000**

Bank	Pin Description	Pin Number	No Connect in XC2V2000
5	IO_L73P_5	AJ20	
5	IO_L72N_5	AG18	
5	IO_L72P_5	AG19	
5	IO_L71N_5	AF18	
5	IO_L71P_5	AF19	
5	IO_L70N_5	AK20	
5	IO_L70P_5	AK21	
5	IO_L69N_5/VREF_5	AH20	
5	IO_L69P_5	AH21	
5	IO_L68N_5	AD19	
5	IO_L68P_5	AD20	
5	IO_L67N_5	AL21	
5	IO_L67P_5	AL22	
5	IO_L54N_5	AG20	
5	IO_L54P_5	AG21	
5	IO_L53N_5	AB19	
5	IO_L53P_5	AB20	
5	IO_L52N_5	AJ21	
5	IO_L52P_5	AJ22	
5	IO_L51N_5/VREF_5	AF20	
5	IO_L51P_5	AF21	
5	IO_L50N_5	AE20	
5	IO_L50P_5	AE21	
5	IO_L49N_5	AK22	
5	IO_L49P_5	AK23	
5	IO_L30N_5	AJ23	NC
5	IO_L30P_5	AJ24	NC
5	IO_L29N_5	AC20	NC
5	IO_L29P_5	AC21	NC
5	IO_L28N_5	AL23	NC
5	IO_L28P_5	AL24	NC
5	IO_L27N_5/VREF_5	AL25	NC
5	IO_L27P_5	AL26	NC
5	IO_L26N_5	AD21	NC
5	IO_L26P_5	AD22	NC
5	IO_L25N_5	AH23	NC
5	IO_L25P_5	AH24	NC
5	IO_L24N_5	AG22	

Table 14: **BF957 — XC2V2000, XC2V3000, XC2V4000, and XC2V6000**

Bank	Pin Description	Pin Number	No Connect in XC2V2000
7	IO_L06N_7	E28	
7	IO_L05P_7	K22	
7	IO_L05N_7	K21	
7	IO_L04P_7	F29	
7	IO_L04N_7	E29	
7	IO_L03P_7/VREF_7	H26	
7	IO_L03N_7	H25	
7	IO_L02P_7/VRN_7	G26	
7	IO_L02N_7/VRP_7	F27	
7	IO_L01P_7	D30	
7	IO_L01N_7	D29	
0	VCCO_0	C18	
0	VCCO_0	C25	
0	VCCO_0	F22	
0	VCCO_0	H18	
0	VCCO_0	L17	
0	VCCO_0	L18	
0	VCCO_0	L19	
0	VCCO_0	L20	
0	VCCO_0	M17	
0	VCCO_0	M18	
0	VCCO_0	M19	
1	VCCO_1	C7	
1	VCCO_1	C14	
1	VCCO_1	F10	
1	VCCO_1	H14	
1	VCCO_1	L12	
1	VCCO_1	L13	
1	VCCO_1	L14	
1	VCCO_1	L15	
1	VCCO_1	M13	
1	VCCO_1	M14	
1	VCCO_1	M15	
2	VCCO_2	G3	
2	VCCO_2	K6	
2	VCCO_2	M11	
2	VCCO_2	N11	

Table 14: **BF957 — XC2V2000, XC2V3000, XC2V4000, and XC2V6000**

Bank	Pin Description	Pin Number	No Connect in XC2V2000
NA	DXP	B28	
NA	VBATT	D5	
NA	RSVD	B4	
NA	VCCAUX	B16	
NA	VCCAUX	C2	
NA	VCCAUX	C30	
NA	VCCAUX	T2	
NA	VCCAUX	T30	
NA	VCCAUX	AJ2	
NA	VCCAUX	AJ30	
NA	VCCAUX	AK16	
NA	VCCINT	K15	
NA	VCCINT	K17	
NA	VCCINT	L11	
NA	VCCINT	L16	
NA	VCCINT	L21	
NA	VCCINT	M12	
NA	VCCINT	M16	
NA	VCCINT	M20	
NA	VCCINT	N13	
NA	VCCINT	N14	
NA	VCCINT	N15	
NA	VCCINT	N16	
NA	VCCINT	N17	
NA	VCCINT	N18	
NA	VCCINT	N19	
NA	VCCINT	P13	
NA	VCCINT	P19	
NA	VCCINT	R10	
NA	VCCINT	R13	
NA	VCCINT	R19	
NA	VCCINT	R22	
NA	VCCINT	T11	
NA	VCCINT	T12	
NA	VCCINT	T13	
NA	VCCINT	T19	
NA	VCCINT	T20	